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said compliant elongated electrical conductor is attached to said enlargement by a method elected from the group consisting of solder bonding, wire bonding, laser welding and ultrasonic bonding.

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### REMARKS

Support for the added claims is found throughout the specification and in US application serial number 07/685,368 filed on Oct. 19, 1992 incorporated by reference at page 7, lines 6-8 from the bottom, now issued as US 5,371,654 on December 6, 1994.

Claims 30-52 added herein are substantially identical to the claims of US 6,336,269 B1 which has an earliest claimed priority date of November 16, 1993. The present application is a continuation of US Application Serial Number 08/872,579, filed on 6/11/1997, now Issued as US 6,334,247 B1 which is a divisional of US Application Serial Number 08/754,869, filed on November 22, 1996, now issued as US 5,821,763 on October 13, 1998, which is a continuation of US Application Serial Number 08/055,485, filed on April 30, 1993 and now issued as US 5,635,846 on June 3, 1997. Therefore, US 5,371,654 and US 5,635,846 are both 35 USC 102(e) references against US 6,336,269 B1.

The following is a non-limiting specific exemplary support for the added claims.

Added claim 30 and 54 are supported in the present application in Figs 7-10, 13-15 and the text corresponding thereto, and are supported in US 5,371,654 in Figs 11-15, 23 and the text corresponding thereto.

Added claim 31 and 61 are supported in US 5,371,654 in the sentence bridging col. 6 and 7, in col. 11, lines 34-51 and in col. 10, lines 49-52, and are supported in Fig. 13 of the present application and the text corresponding thereto.

Added claims 34-37, 39-43, 45, 47-52, 55-56 are supported in US 5,371,654. Col. 8, line 35-49 and are supported in the first full paragraph at page 13 of the present specification.

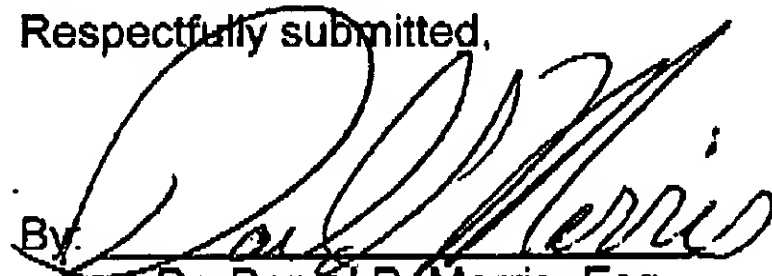
Added claim 38, 44 and 60 are supported in US 5,371,654, Figs. 11-16 and 25 and the text corresponding thereto and in claim 11, and are supported in Figs. 7-13 and the text corresponding thereto and claim 1 of the present specification.

Added claim 46 is supported in US 5,371,654, Col. 6, lines 1-6, and is supported in Figs. 7-10 of the present specification.

Added claim 53 and 62 are supported in US 5,371,654, Col. 4, lines 1-13, and are supported in Figs. 14-15 of the present application and the text corresponding thereto.

Respectfully submitted,

By:



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